CUC-USB3.1-J1ST-AH/UCF-SMD - USB PCB connectors



1332645

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USB PCB connectors, degree of protection: IP20, number of positions: 16, 480 Mbps, material: Metal, connection method: Solder connection, USB 2.0



Your advantages

- · Optimized for SMD reflow soldering processes
- · Can be processed automatically thanks to tape-on-reel packaging

Commercial data

Item number	1332645
Packing unit	1,000 pc
Minimum order quantity	1,000 pc
Sales key	AB14
Product key	ABNDAC
GTIN	4063151629724
Weight per piece (including packing)	0.811 g
Weight per piece (excluding packing)	22.22 g
Customs tariff number	85366930
Country of origin	CN



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Technical data

Product properties

Product type	Data connector (device side)
Туре	USB-C
Sensor type	USB 2.0
Number of positions	16
Connection profile	USB-C
Type of packaging	Tape and Reel
[W] tape width	24.00 mm
[A] coil diameter	330.00 mm
Number of slots	1
Туре	Socket
Shielded	yes
Data management status	
Article revision	00
Allice Tevision	00
Insulation characteristics	
Overvoltage category	1
Degree of pollution	2
Electrical properties	
Rated voltage (III/2)	20 V
Rated surge voltage (III/2)	1500 V
Rated current	5 A
Contact resistance	40 mΩ
Frequency range	10 Hz 55 Hz
Insulation resistance	100 ΜΩ
Transmission medium	Copper
Transmission characteristics (category)	USB 2.0
Transmission speed	480 Mbps
Power transmission	100 W

Connection data

Connection technology	
Connection method	Solder connection

Dimensions

Width	8.94 mm
Height	3.26 mm
Length	7.3 mm
Orientation to PCB	90.00 °



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Material specifications

Color of the housing part	black
Flammability rating according to UL 94	V0
Housing material	Metal
Contact material	Copper alloy
Contact surface material	Gold over nickel
Contact carrier material	LCP

Cable/line

Test voltage Core/Core	100 V
Test voltage Core/Shield	100.00 V
Acceleration	3.1 m/s ²
Halogen-free	yes

Mechanical properties

Mechanical data	
Insertion/withdrawal cycles	> 10000
Insertion force per signal contact	20.00 N
Extraction force per signal contact	< 8 N

Environmental and real-life conditions

Moisture Sensitive Level

Specification EIA 364-1000 Frequency 10-55 Hz Sweep speed 1 octave/min Amplitude 1.52 mm Test duration 2.00 h Contact resistance R1 40.00 mΩ Test specification Specification 60068-2-27 Acceleration 30.00 g Number of shocks per direction 18.00 Ambient conditions IP20 Degree of protection IP20 Ambient temperature (operation) -55 °C 85 °C Auting type SMD soldering	Test specification	
Sweep speed 1 octave/min Amplitude 1.52 mm Test duration 2.00 h Contact resistance R1 40.00 mΩ Test specification Specification 60068-2-27 Acceleration 30.00 g Number of shocks per direction 18.00 Armbient conditions IP20 Ambient temperature (operation) -55 °C 85 °C Mounting type SMD soldering Processing notes SMD soldering	Specification	EIA 364-1000
Amplitude1.52 mmTest duration2.00 hContact resistance R140.00 mΩTest specificationSpecification60068-2-27Acceleration30.00 gNumber of shocks per direction18.00Ambient conditionsIP20Ambient temperature (operation)-55 °C 85 °CAutom of the specificationMounting typeSMD soldering	Frequency	10-55 Hz
Test duration 2.00 h Contact resistance R1 40.00 mΩ Test specification 60068-2-27 Specification 30.00 g Acceleration 30.00 g Number of shocks per direction 18.00 Ambient conditions IP20 Degree of protection IP20 Ambient temperature (operation) -55 °C 85 °C	Sweep speed	1 octave/min
Contact resistance R1 40.00 mΩ Test specification 60068-2-27 Specification 30.00 g Acceleration 30.00 g Number of shocks per direction 18.00 Ambient conditions IP20 Degree of protection IP20 Ambient temperature (operation) -55 °C 85 °C Mounting type SMD soldering	Amplitude	1.52 mm
Test specification 60068-2-27 Acceleration 30.00 g Number of shocks per direction 18.00 Ambient conditions IP20 Ambient temperature (operation) -55 °C 85 °C Mounting type SMD soldering Processing notes SMD soldering	Test duration	2.00 h
Specification 60068-2-27 Acceleration 30.00 g Number of shocks per direction 18.00 Ambient conditions IP20 Ambient temperature (operation) -55 °C 85 °C Mounting type SMD soldering	Contact resistance R ₁	40.00 mΩ
Acceleration 30.00 g Number of shocks per direction 18.00 Ambient conditions IP20 Degree of protection IP20 Ambient temperature (operation) -55 °C 85 °C	Test specification	
Number of shocks per direction 18.00 Ambient conditions IP20 Degree of protection IP20 Ambient temperature (operation) -55 °C 85 °C	Specification	60068-2-27
Ambient conditions IP20 Degree of protection IP20 Ambient temperature (operation) -55 °C 85 °C	Acceleration	30.00 g
Degree of protection IP20 Ambient temperature (operation) -55 °C 85 °C Mounting Mounting type Processing notes SMD soldering	Number of shocks per direction	18.00
Ambient temperature (operation) -55 °C 85 °C Mounting Mounting type Processing notes SMD soldering	Ambient conditions	
Mounting Mounting type SMD soldering Processing notes	Degree of protection	IP20
Mounting type SMD soldering Processing notes	Ambient temperature (operation)	-55 °C 85 °C
Processing notes	Mounting	
	Mounting type	SMD soldering
Process SMD	Processing notes	
	Process	SMD

MSL 1

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Classification temperature T _c	260 °C
Solder cycles in the reflow	3

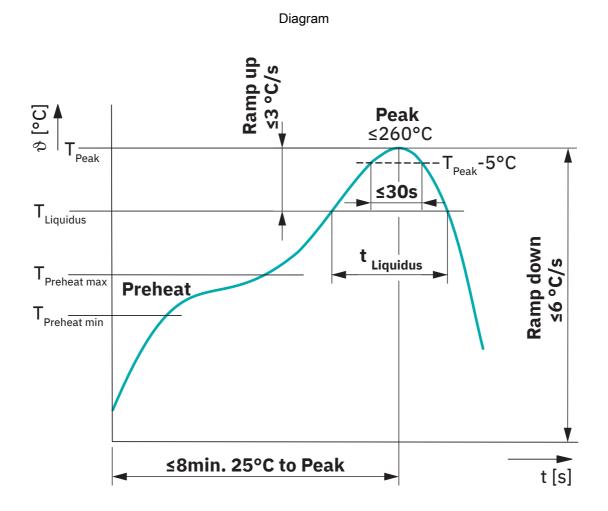
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Drawings



Classification reflow soldering profile



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Classifications

ECLASS

ECLASS-12.0 27440390	
ECLASS-13.0 27460201	

ETIM

	ETIM 9.0	EC002637	
UN	UNSPSC		
	UNSPSC 21.0	39121400	

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Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
China RoHS	
Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits
EU REACH SVHC	
REACH candidate substance (CAS No.)	No substance above 0.1 wt%

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